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TITLE:

DETECTION OF FILM THICKNESS TO BE ETCHED, FILM

THICKNESS DETECTOR, AND ETCHER

PUBN-DATE:

March 26, 1992

INVENTOR-INFORMATION:

NAME

COUNTRY

WATANABE, KOJI

ASSIGNEE-INFORMATION:

NAME

COUNTRY

FUJITSU LTD N/A

APPL-NO: JP02213406

APPL-DATE: August 10, 1990

INT-CL (IPC): H01L021/302 , H01L021/66

US-CL-CURRENT: 216/60, 356/FOR.112

ABSTRACT:

PURPOSE: To enable high-precision detection of the thickness of a remainder of a film to be etched by irradiating a film to be etched with laser light to detect variation in light intensity caused by interference of light beams reflected from the bottom and top faces of the film.

CONSTITUTION: The periodical variation in <u>light intensity</u> is calculated by detection of variation in <u>light intensity</u> caused by <u>interference</u> of laser beams <u>reflected</u> from the bottom and top faces of a film to be etched W. Next, reference <u>time t2 is made of a point of time</u> when any of the <u>maximum and minimum values of light intensity and the maximum and minimum values of variations with time of light intensity are reached. The thickness d1 of the film to be etched W at this reference time t2 is operated, and further etching amount α t after the reference time t2 is determined. This process <u>enables high-precision detection</u> of the thickness D of a residual of a film to be etched W which is being etched.</u>

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